

TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

ETAS ID: TM757221

| | | | |
|---|---|-----------------------|-----------------------|
| SUBMISSION TYPE: | NEW ASSIGNMENT | | |
| NATURE OF CONVEYANCE: | SECURITY INTEREST | | |
| CONVEYING PARTY DATA | | | |
| Name | Formerly | Execution Date | Entity Type |
| KANDJI, INC. | | 09/22/2022 | Corporation: DELAWARE |
| RECEIVING PARTY DATA | | | |
| Name: | JPMORGAN CHASE BANK, N.A. | | |
| Street Address: | 383 Madison Avenue, 22nd Floor | | |
| City: | New York | | |
| State/Country: | NEW YORK | | |
| Postal Code: | 10017 | | |
| Entity Type: | National Banking Association: UNITED STATES | | |
| PROPERTY NUMBERS Total: 5 | | | |
| Property Type | Number | Word Mark | |
| Registration Number: | 627863 | | |
| Serial Number: | 97416886 | | |
| Serial Number: | 97416905 | KANDJI | |
| Registration Number: | 6331993 | MDM+ | |
| Registration Number: | 6248982 | MDM+ | |
| CORRESPONDENCE DATA | | | |
| Fax Number: | | | |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | | | |
| Phone: | 8448182387 | | |
| Email: | ipteam@cogencyglobal.com | | |
| Correspondent Name: | Jennifer Tindie | | |
| Address Line 1: | 1025 Connecticut Avenue NW | | |
| Address Line 2: | Suite 712 | | |
| Address Line 4: | Washington, NEW YORK 20036 | | |
| ATTORNEY DOCKET NUMBER: | 1790790 | | |
| NAME OF SUBMITTER: | ANDREW NASH | | |
| SIGNATURE: | /ANDREW NASH/ | | |
| DATE SIGNED: | 09/23/2022 | | |

OP \$140.00 627863

Total Attachments: 7

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INTELLECTUAL PROPERTY SECURITY AGREEMENT

This Intellectual Property Security Agreement (“Agreement”) is entered into as of September 22, 2022, by and between JPMORGAN CHASE BANK, N.A. (“Lender”), as the lender party to the Credit Agreement referred to below, and KANDJI, INC., a Delaware corporation (“Grantor”).

RECITALS

A. Lender has agreed to make certain advances of money and to extend certain financial accommodation (the “Loans”) to the Loan Parties (as defined in the Credit Agreement), in the amounts and manner set forth in that certain Credit and Security Agreement by and among Lender and the Loan Parties dated as of the same date hereof (as the same may be amended, modified or supplemented from time to time, collectively, the “Credit Agreement”); capitalized terms used herein are as defined in the Credit Agreement unless otherwise defined in this Agreement). Lender is willing to make the Loans to the Loan Parties, but only upon the condition, among others, that Grantor shall grant to Lender a security interest in the Collateral, including certain Copyrights, Trademarks, and Patents (as each term is described below) to secure the obligations of Grantor under the Credit Agreement.

B. Pursuant to the terms of the Credit Agreement, Grantor has granted to Lender a security interest in all of Grantor’s right, title and interest, whether presently existing or hereafter acquired, in, to and under all of the Collateral.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, and intending to be legally bound, as collateral security for the prompt and complete payment when due of its obligations under the Credit Agreement, Grantor hereby represents, warrants, covenants and agrees as follows:

AGREEMENT

1. Grant of Security Interest. Grantor grants and pledges to Lender a security interest in all of Grantor’s right, title and interest in, to and under its intellectual property (all of which shall collectively be called the “Intellectual Property Collateral”), including, without limitation, the following:

(a) Any and all copyright rights, copyright applications, copyright registrations and like protections in each work or authorship and derivative work thereof, whether published or unpublished and whether or not the same also constitutes a trade secret, now or hereafter existing, created, acquired or held, including without limitation those set forth on Exhibit A attached hereto (collectively, the “Copyrights”);

(b) Any and all trade secrets, and any and all intellectual property rights in computer software and computer software products now or hereafter existing, created, acquired or held;

(c) Any and all design rights that may be available to Grantor now or hereafter existing, created, acquired or held;

(d) All patents, patent applications and like protections including, without limitation, improvements, divisions, continuations, renewals, reissues, extensions and continuations-in-part of the same, including without limitation the patents and patent applications set forth on Exhibit B attached hereto (collectively, the “Patents”);

(e) Any trademark and servicemark rights, whether registered or not, applications to register and registrations of the same and like protections, and the entire goodwill of the business of Grantor

connected with and symbolized by such trademarks, including without limitation those set forth on Exhibit C attached hereto (collectively, the "Trademarks");

(g) Any and all claims for damages by way of past, present and future infringements of any of the rights included above, with the right, but not the obligation, to sue for and collect such damages for said use or infringement of the intellectual property rights identified above;

(h) All licenses or other rights to use any of the Copyrights, Patents, or Trademarks, and all license fees and royalties arising from such use to the extent permitted by such license or rights;

(i) All amendments, extensions, renewals and extensions of any of the Copyrights, Trademarks, or Patents; and

(j) All proceeds and products of the foregoing, including without limitation all payments under insurance or any indemnity or warranty payable in respect of any of the foregoing.

2. Recordation. The parties hereto authorize and request that the Commissioner of Patents, the Commissioner for Trademarks and the Register of Copyrights of the United States record this security interest in the Intellectual Property Collateral.

3. Authorization. Grantor hereby authorizes Lender to (a) modify this Agreement unilaterally by amending the exhibits to this Agreement to include any Intellectual Property Collateral which Grantor obtains subsequent to the date of this Agreement, and (b) file a duplicate original of this Agreement containing amended exhibits reflecting such new Intellectual Property Collateral, in each case, providing notice thereof to the Grantor.

4. Loan Documents. This Agreement has been entered into pursuant to and in conjunction with the Credit Agreement, which is hereby incorporated by reference. The provisions of the Credit Agreement shall supersede and control over any conflicting or inconsistent provision herein. The rights and remedies of Lender with respect to the Intellectual Property Collateral are as provided by the Credit Agreement and related documents, and nothing in this Agreement shall be deemed to limit such rights and remedies.

5. Execution in Counterparts. This Agreement may be executed in counterparts (and by different parties hereto in different counterparts), each of which shall constitute an original, but all of which when taken together shall constitute a single contract. Delivery of an executed counterpart of a signature page to this Agreement by facsimile or in electronic (i.e., "pdf" or "tif" format) shall be effective as delivery of a manually executed counterpart of this Agreement.

6. Successors and Assigns. This Agreement will be binding on and shall inure to the benefit of the parties hereto and their respective successors and assigns.

7. Governing Law. This Agreement and any claim, controversy, dispute or cause of action (whether in contract or tort or otherwise) based upon, arising out of or relating to this Agreement and the transactions contemplated hereby and thereby shall be governed by, and construed in accordance with, the laws of the United States and the State of New York, without giving effect to any choice or conflict of law provision or rule (whether of the State of New York or any other jurisdiction).

[Signatures included on the following page]

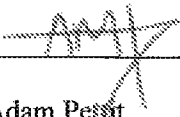
IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

GRANTOR:

Address:

KANDJI, INC.

Kandji, Inc.
101 West Broadway, Suite 1440
San Diego, CA 92101
Attention: Danny Zorotovich

By:  _____

Name: Adam Pessit

Title: Chief Executive Officer

[Signature page to Intellectual Property Security Agreement]

TRADEMARK

REEL: 007854 FRAME: 0538

IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

GRANTOR:

Address:

KANDJI, INC.

Kandji, Inc.
101 West Broadway, Suite 1440
San Diego, CA 92101
Attention: Danny Zorotovich

By: _____

Name: _____

Title: _____

LENDER:

Address:

JPMORGAN CHASE BANK, N.A.

JPMorgan Chase
383 Madison Avenue, 22nd Floor
New York, NY 10017
Attention: Christopher Finch

By: Christopher Finch

Name: Christopher Finch

Title: Associate

[Signature page to Intellectual Property Security Agreement]

TRADEMARK
REEL: 007854 FRAME: 0539

EXHIBIT A

Copyrights

| <u>Description</u> | <u>Registration/ Application Number</u> | <u>Registration/ Application Date</u> |
|--------------------|---|---|
| N/A | | |

EXHIBIT B

Patents

| <u>Description</u> | <u>Application Number</u> | <u>Application Date</u> | <u>Patent Number</u> |
|---|---------------------------|--|---|
| <u>Systems and methods for deploying configurations on computing devices and validating compliance with the configurations during scheduled intervals</u> | <u>16/530,290</u> | <u>8/2/19</u> | <u>11102251</u> |
| <u>Systems and methods for deploying configurations on computing devices and validating compliance with the configurations during scheduled intervals (Utility: Continuation)</u> | <u>17/445473</u> | <u>8/19/21</u> <u>Pub Date:</u> <u>12/9/21</u> | <u>N/A</u> <u>Pub No.:</u> <u>20210385254</u> |
| <u>User device authentication gateway module (Utility: Non-Provisional Patent)</u> | <u>N/A</u> | <u>11/2/21</u> | <u>N/A</u> |
| <u>Customizable initialization orchestration module (Utility: Non-Provisional Patent)</u> | <u>N/A</u> | <u>5/12/22</u> | <u>N/A</u> |

EXHIBIT C

Trademarks

| <u>Description</u> | <u>Serial Application Number</u> | <u>Application Date</u> | <u>Reg No.:</u> |
|----------------------------------|----------------------------------|-------------------------|------------------|
| <u>KANDJI</u> | <u>88090679</u> | <u>8/23/18</u> | <u>627863</u> |
| <u>Bee Logo</u> | <u>97416886</u> | <u>5/18/22</u> | <u>[Pending]</u> |
| <u>Bee + Word Logo</u> | <u>97416905</u> | <u>5/18/22</u> | <u>[Pending]</u> |
| <u>MDM+ (in black rectangle)</u> | <u>88891211</u> | <u>4/28/20</u> | <u>6331993</u> |
| <u>MDM+</u> | <u>88891054</u> | <u>4/28/20</u> | <u>6248982</u> |